TOSHIBA LED Lamp InGaAlP Red Light Emission

TLRE262A

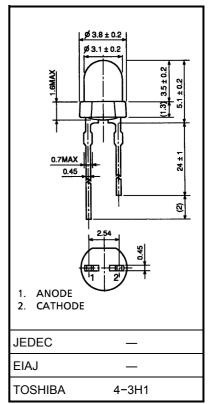
Panel Circuit Indicator

Unit in mm

- 3.1mm diameter(T1)
- InGaAlP red LED
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity red light emission Recommended forward current: IF = 15 \sim 20 mA (DC)
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- High power luminous intensity
- Applications: Suitable for backlighting.

Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Forward current (DC)	I _F	50	mA	
Reverse voltage	V_{R}	4	V	
Power dissipation	P _D	125	mW	
Operating temperature range	T _{opr}	-30~85	°C	
Storage temperature range	T _{stg}	-40~120	°C	



Weight: 0.14 g

Electrical And Optical Characteristics (Ta = 25°C)

Chara	octeristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Forward voltage		V _F	I _F = 20 mA		_	1.85	2.4	V
Reverse current		I _R	V _R = 4 V		_	_	50	μΑ
Luminous intensity	TLRE262A	- I _V	I _F = 20 mA	(Note)	47.6	150	_	mcd
	TLRE262A (MN)				47.6	_	230	
Peak emission wa	velength	λρ	I _F = 20 mA		_	644	_	nm
Spectral line half width		Δλ	I _F = 20 mA		_	18	_	nm
Dominant wavelength		λ _d	I _F = 20 mA		_	630	_	nm

(Note): Lamps are classified into the following ranks according to their luminous intensity.

Measurement tolerance for each limit is ±15%.

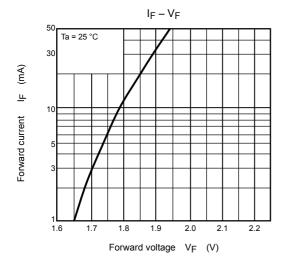
M: 56-112 mcd, N: 100-200 mcd, P: 180-360 mcd.

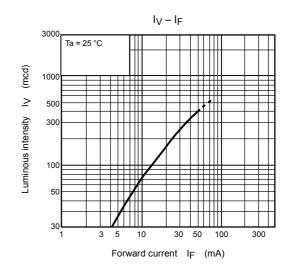
Precaution

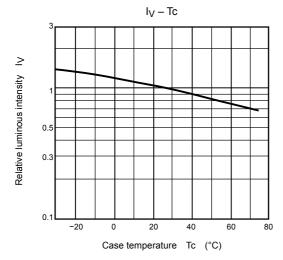
Please be careful of the followings

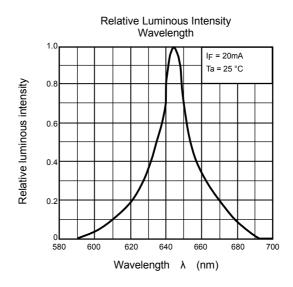
- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: Up to 2mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

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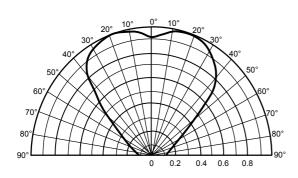


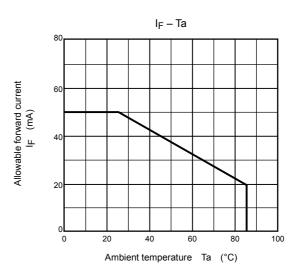


Radiation Pattern

Ta = 25 °C

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2002-09-25

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